The DS1225Y executes a read cycle whenever \overline{WE} (Write Enable) is inactive (high) and \overline{CE} (Chip Enable) and \overline{OE} (Output Enable) are active (low). The unique address specified by the 13 address inputs (A₀-A₁₂) defines which of the 8192 bytes of data is to be accessed. Valid data will be available to the eight data output drivers within t_{ACC} (Access Time) after the last address input signal is stable, providing that \overline{CE} and \overline{OE} access times are also satisfied. If \overline{CE} and \overline{OE} access times are not satisfied, then data access must be measured from the later-occurring signal and the limiting parameter is either t_{CO} for \overline{CE} or t_{OE} for \overline{OE} rather than address access.

WRITE MODE

The DS1225Y executes a write cycle whenever the \overline{WE} and \overline{CE} signals are active (low) after address inputs are stable. The later-occurring falling edge of \overline{CE} or \overline{WE} will determine the start of the write cycle. The write cycle is terminated by the earlier rising edge of \overline{CE} or \overline{WE} . All address inputs must be kept valid throughout the write cycle. \overline{WE} must return to the high state for a minimum recovery time (t_{WR}) before another cycle can be initiated. The \overline{OE} control signal should be kept inactive (high) during write cycles to avoid bus contention. However, if the output drivers are enabled (\overline{CE} and \overline{OE} active) then \overline{WE} will disable the outputs in t_{ODW} from its falling edge.

DATA RETENTION MODE

The DS1225Y provides full functional capability for V_{CC} greater than 4.5 volts and write protects at 4.25 nominal. Data is maintained in the absence of V_{CC} without any additional support circuitry. The DS1225Y constantly monitors V_{CC} . Should the supply voltage decay, the NV SRAM automatically write protects itself, all inputs become "don't care," and all outputs become high impedance. As V_{CC} falls below approximately 3.0 volts, a power switching circuit connects the lithium energy source to RAM to retain data. During power-up, when V_{CC} rises above approximately 3.0 volts, the power switching circuit connects external V_{CC} to RAM and disconnects the lithium energy source. Normal RAM operation can resume after V_{CC} exceeds 4.5 volts.

ABSOLUTE MAXIMUM RATINGS

Voltage on Any Pin Relative to Ground	-0.3V to +6.0V
Operating Temperature Range	
Commercial:	0° C to $+70^{\circ}$ C
Industrial:	-40°C to +85°C
Storage Temperature	-40°C to +85°C
Lead Temperature (soldering, 10s)	+260°C
Note: EDIP is wave or hand soldered only.	

This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operation sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

RECOMMENDED DC OPERATING CONDITIONS					(T _A : See	Note 10)
PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
Power Supply Voltage	V _{CC}	4.5	5.0	5.5	V	
Input Logic 1	V _{IH}	2.2		VCC	V	
Input Logic 0	V _{IL}	0.0		+0.8	V	

DC ELECTRICAL CHARAC	S	(T _A : See Note 10; V _{CC} = 5V ± 10%)				
PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
Input Leakage Current	I _{IL}	-1.0		+1.0	μA	
I/O Leakage Current	т	1.0		10		
$\overline{CE} \ge V_{IH} \le V_{CC}$	I _{IO}	-1.0		+1.0	μΑ	
Output Current @ 2.4V	I _{OH}	-1.0			mA	
Output Current @ 0.4V	I _{OL}	2.0			mA	
Standby Current $\overline{CE} = 2.2V$	1 _{CCS1}		5	10	mA	
Standby Current $\overline{CE} = V_{CC} - 0.5V$	1 _{CCS2}		3	5	mA	
Operating Current t _{CYC} =200ns (Commercial)	1 _{CCO1}			75	mA	
Operating Current t _{CYC} = 200ns	I _{CCO1}			85	mA	
(Industrial)	10001			05		
Write Protection Voltage	V _{TP}		4.25		V	10

NOT RECOMMENDED FOR NEW DESIGNS

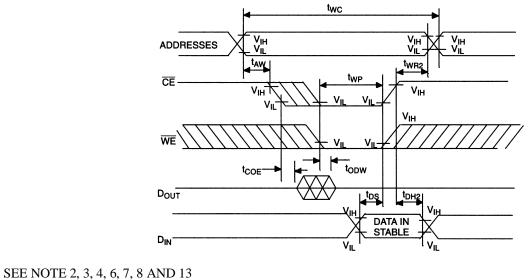
DS1225Y

AC ELECTRICAL CHAR	S (T _A :				
		DS122	25Y-150		
PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTES
Read Cycle Time	t _{RC}	150		ns	
Access Time	t _{ACC}		150	ns	
\overline{OE} to Output Valid	t _{OE}		70	ns	
\overline{CE} to Output Valid	t _{CO}		150	ns	
\overline{OE} or \overline{CE} to	t _{COE}	5		ns	5
Output Active					
Output High Z from	t _{OD}		35	ns	5
Deselection					
Output Hold from	t _{OH}	5		ns	
AddressChange					
Write Cycle Time	t _{WC}	150		ns	
Write Pulse Width	t _{WP}	100		ns	3
Address Setup Time	t _{AW}	0		ns	
Write Recovery Time	t _{WR1}	0		ns	12
	t _{WR2}	10		ns	13
Output High Z from \overline{WE}	t _{ODW}		35	ns	5
Output Active from \overline{WE}	t _{OEW}	5		ns	5
Data Setup Time	t _{DS}	60		ns	4
Data Hold Time	t _{DH1}	0		ns	12
	t _{DH2}	10		ns	13

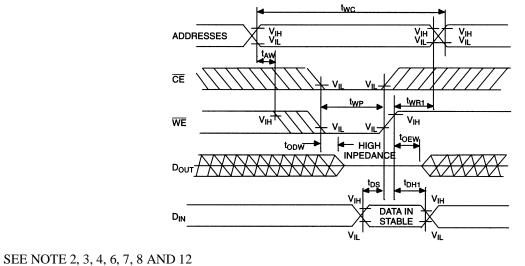
CAPACITANCE

 $(T_A = +25^{\circ}C)$

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	NOTES
Input Capacitance	C _{IN}			10	pF	
Input/Output Capacitance	C _{I/O}			10	pF	

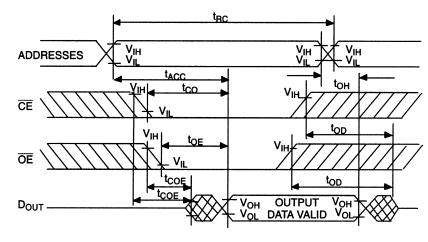


WRITE CYCLE 2



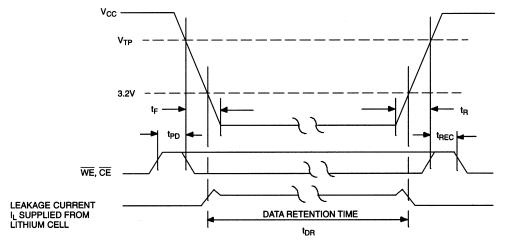
WRITE CYCLE 1

SEE NOTE 1



READ CYCLE

POWER-DOWN/POWER-UP CONDITION



SEE NOTE 11

POWER-DOWN/POWER-UP TIMING

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTES
$\overline{\text{CE}}$ at V _{IH} before Power-Down	t _{PD}	0		μs	11
V_{CC} Slew from V_{TP} to 0V	t _F	100		μs	
V_{CC} Slew from 0V to V_{TP}	t _R	0		μs	
$\overline{\text{CE}}$ at V _{IH} after Power-Up	t _{REC}		2	ms	

					$(T_A = +25^{\circ}C)$
PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTES
Expected Data Retention Time	t _{DR}	10		years	9

WARNING:

Under no circumstance are negative undershoots, of any amplitude, allowed when device is in battery backup mode.

NOTES:

- 1. $\overline{\text{WE}}$ is high for a read cycle.
- 2. $\overline{OE} = V_{IH}$ or V_{IL} . If $\overline{OE} = V_{IH}$ during a write cycle, the output buffers remain in a high impedance state.
- 3. t_{WP} is specified as the logical AND of \overline{CE} and \overline{WE} . t_{WP} is measured from the latter of \overline{CE} or \overline{WE} going low to the earlier of \overline{CE} or \overline{WE} going high.
- 4. t_{DS} is measured from the earlier of \overline{CE} or \overline{WE} going high.
- 5. These parameters are sampled with a 5 pF load and are not 100% tested.
- 6. If the \overline{CE} low transition occurs simultaneously with or later than the \overline{WE} low transition in Write Cycle 1, the output buffers remain in a high-impedance state during this period.
- 7. If the \overline{CE} high transition occurs prior to or simultaneously with the \overline{WE} high transition, the output buffers remain in a high-impedance state during this period.

- 8. If \overline{WE} is low or the \overline{WE} low transition occurs prior to or simultaneously with the \overline{CE} low transition, the output buffers remain in a high-impedance state during this period.
- 9. Each DS1225Y is marked with a 4-digit date code AABB. AA designates the year of manufacture. BB designates the week of manufacture. The expected t_{DR} is defined as starting at the date of manufacture.
- 10. All AC and DC electrical characteristics are valid over the full operating temperature range. For commercial products, this range is 0°C to 70°C. For industrial products (IND), this range is -40°C to +85°C.
- 11. In a power down condition the voltage on any pin may not exceed the voltage on V_{CC} .
- 12. t_{WR1} , t_{DH1} are measured from \overline{WE} going high.
- 13. t_{WR2} , t_{DH2} are measured from \overline{CE} going high.
- 14. DS1225Y modules are recognized by Underwriters Laboratories (UL) under file E99151 (R).

DC TEST CONDITIONS

Outputs open. All voltages are referenced to ground.

AC TEST CONDITIONS

Output Load: 100pF + 1TTL Gate Input Pulse Levels: 0-3.0V Timing Measurement Reference Levels Input:1.5V Output: 1.5V Input Pulse Rise and Fall Times: 5ns

ORDERING INFORMATION

PART	TEMP RANGE	SUPPLY TOLERANCE	SPEED GRADE (ns)	PIN-PACKAGE
DS1225Y-150+	0° C to $+70^{\circ}$ C	$5V \pm 10\%$	150	28 720 EDIP
DS1225Y- 150IND+	-40° C to $+85^{\circ}$ C	$5V \pm 10\%$	150	28 720 EDIP

+Denotes a lead(Pb)-free/RoHS-compliant package.

PACKAGE INFORMATION

For the latest package outline information and land patterns, go to <u>www.maxim-ic.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
28 EDIP	MDT28+2	<u>21-0245</u>	—

REVISION HIS	STORY	
REVISION DATE	DESCRIPTION	PAGES CHANGED
121907	Added the <i>Package Information</i> table; removed the DIP module package drawing and dimension table	7
10/10	Added Not Recommended for New Designs status; updated the storage information, soldering temperature, and lead temperature information in the <i>Absolute Maximum Ratings</i> section; removed the -170 and -200 MIN/MAX information from the <i>AC Electrical Characteristics</i> table; added the updated the <i>Ordering Information</i> table	1, 3, 4, 7